



Soldering Reflow:

Preheat condition: 150 ~200°C / 60~120 sec.

Allowed time above 217°C : 60~90 sec.

Max temperature: 260°C .

Max time at max temperature: 10 sec.

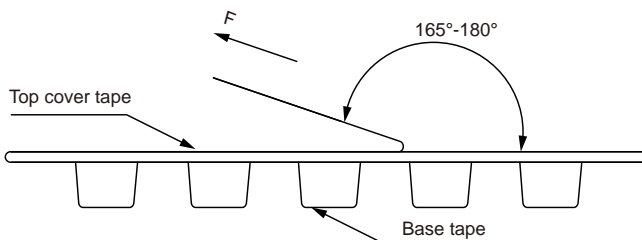
Allowed Reflow time: 2x max.

Packaging Information:

Tape Dimension:

Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDTA4020	4.5± 0.1	4.5± 0.1	1.5± 0.1	4.0± 0.1	8.0± 0.1	12.0± 0.3	2.3± 0.1	1.75± 0.1	0.35± 0.05

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.1 to 1.3 N



Reel Dimension: [mm]



Packaging Quantity: